DECEMBER 1983-REVISED MARCH 1988

- Converts TTL Voltage Levels to MOS Levels
- · High Sink-Current Capability
- Input Clamping Diodes Simplify System Design
- Open-Collector Driver for Indicator Lamps and Relays
- Inputs Fully Compatible with Most TTL Circuits

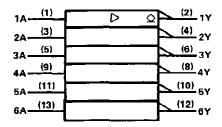
SN5406, SN5416 J OR W PACKAGE								
SN7406, SN7416 N PACKAGE								
(TOP VIEW)								

1A□ī		□vcc
1 Y 🗖 2	13	6A
2A □3	12	D6Y
2Y 🗆 4	11	□ 5A
3 △ 🗖 5	10	<u></u> 5Υ
37 🛮 6	9	] 4A
GND 🛮 7	8	□ 4Y

### description

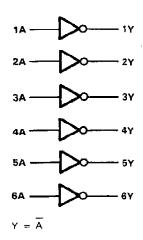
These monolithic TTL hex inverter buffers/drivers feature high-voltage open-collector outputs for interfacing with high-level circuits (such as MOS), or for driving high-current loads (such as lamps or relays), and are also characterized for use as inverter buffers for driving TTL inputs. The SN5406 and SN7406 have minimum breakdown voltages of 30 volts and the SN5416 and SN7416 have minimum breakdown voltages of 15 volts. The maximum sink current is 30 milliamperes for the SN5406 and SN5416, and 40 milliamperes for the SN7406 and SN7416.

### logic symbol†

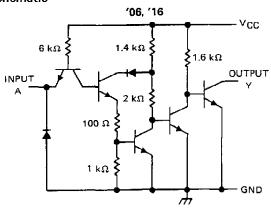


 $^\dagger$  This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

### logic diagram (positive logic)



### ..... schematic



Resistor values shown are nominal.

# SN5406, SN5416, SN7406, SN7416 HEX INVERTER BUFFERS/DRIVERS WITH **OPEN-COLLECTOR HIGH-VOLTAGE OUTPUTS**

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

NOTES: 1. Voltage values are with respect to network ground terminal.

2. This is the maximum voltage which should be applied to any output when it is in the off state.

### recommended operating conditions

			SN5406			SN7406			
			MIN	SN5416 NOM	MAX	MIN	SN7416 NOM	MAX	UNIT
Vcc	Supply voltage		4.5	5	5.5	4.75	5	5.25	V
$v_{\text{IH}}$	H High-level input voltage		2			2			V
VIL	ow-level input voltage				0.8			0.8	V
·	High-level output voltage	′06			30			30	V
∨он		16			15			15	· ·
IOL	Low-level output current				30			40	mΑ
ТД	Operating free-air temperature		- 55		125	0		70	°C

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS <sup>†</sup>			SN5406 SN5416			SN7406 SN7416			UNIT
					TYP‡	MAX	MIN	TYP‡	MAX	
VIK	V <sub>CC</sub> = MIN,	I <sub>I</sub> = - 12 mA				- 1.5			<b>– 1.5</b>	
Тон	V <sub>CC</sub> = MIN,	V <sub>IL</sub> = 0.8 V, V <sub>OH</sub> = §				0.25			0.25	mA
			IOL = 16 mA			0.4			0.4	V
VOL	VCC = MIN,	V <sub>IH</sub> ≈ 2 V	OL = ¶			0.7			0.7	Ĭ .
	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 5.5 V				1			1	mΑ
I <sub>(H</sub>	V <sub>CC</sub> = MAX.	V <sub>IH</sub> = 2.4 V				40			40	μА
ηL	V <sub>CC</sub> = MAX,	V <sub>IL</sub> = 0.4 V				<b>– 1.6</b>			- 1.6	mA
<b>І</b> ссн	Vcc = MAX				30	48		30	48	mA
CCL	V <sub>CC</sub> = MAX				32	51		32	51	mA

f For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

### switching characteristics, VCC = 5 V, TA = 25°C (see note 3)

	PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST COM	MIN	TYP	MAX	UNIT	
$\vdash$	†PLH			0 - 110 0	C <sub>L</sub> = 15 pF		10	15	ns
$\vdash$	tPHL .	Д	T	R <sub>L</sub> = 110 Ω			15	23	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



<sup>‡</sup> All typical values are at  $V_{CC} = 5$  V,  $T_A = 25^{\circ}$  C,  $\frac{1}{5}$  V<sub>OH</sub> = 30 V for '06 and 15 V for '16.

<sup>¶</sup> IOL = 30 mA for SN54' and 40 mA for SN74'.

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